

## LO564TRO4-B0G

### Features

All Plastic Mold Type  
 Elliptical Package  
 High Luminous Intensity  
 Tinted Diffused Lens  
 Wide Viewing Angle Up To 100° x 50°

### Applications

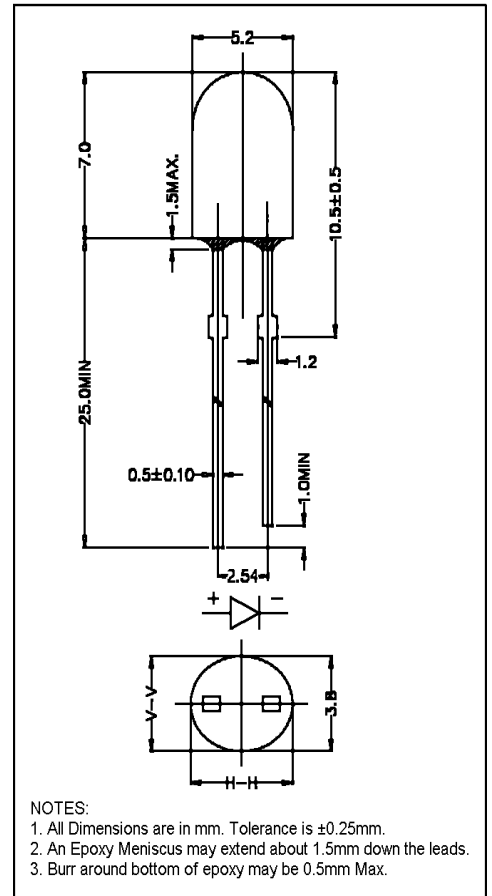
Backlighting  
 VMS  
 Full Color/RGB Video Screens  
 Time/Temperature Boards

### Maximum Ratings (Ta=25°C)

Characteristic	Symbol	Max.	Unit
Forward Current	I <sub>F</sub>	50	mA
Reverse Voltage	V <sub>R</sub>	5	V
Power Dissipation	P <sub>D</sub>	150.00	mW
Operating Temperature	T <sub>opr</sub>	-40 ~ +95	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C
Soldering Temperature	T <sub>sol</sub>	260	°C
Soldering Time	-	for 5 sec. max	-

### Opto-Electrical Characteristics (Ta=25°C)

Characteristic	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	1.70	2.10	2.60	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	-	-	100	μA
Luminous Intensity	I <sub>v</sub>	I <sub>F</sub> =20mA	390.00	700.00	-	mcd
Viewing Angle	2θ <sup>1/2</sup>	-	-	100° x 45°	-	deg.
Peak Wavelength	λ <sub>p</sub>	I <sub>F</sub> =20mA	-	625	-	nm
Dominant Wavelength	λ <sub>d</sub>	I <sub>F</sub> =20mA	-	618	-	nm
Spectral Line Half Width	Δλ	I <sub>F</sub> =20mA	-	23	-	nm



### LO564TRO4-B0G Graphs

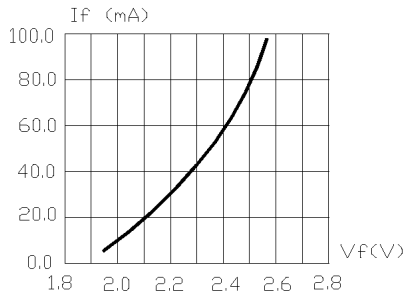


FIG.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

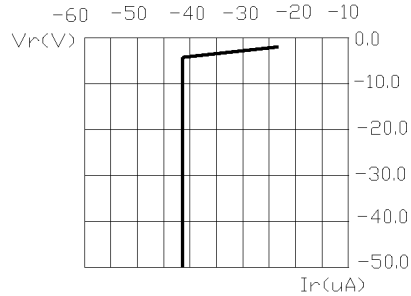


FIG.2 REVERSE CURRENT VS. REVERSE VOLTAGE.

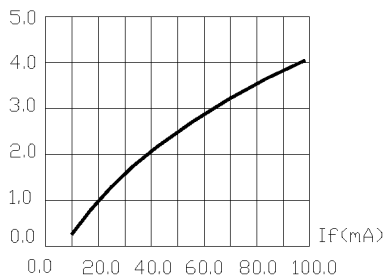


FIG.3 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT.

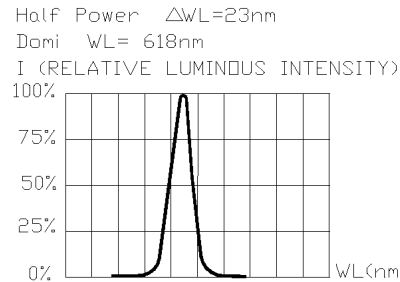


FIG.4 RELATIVE LUMINOUS INTENSITY VS. WAVELENGTH.

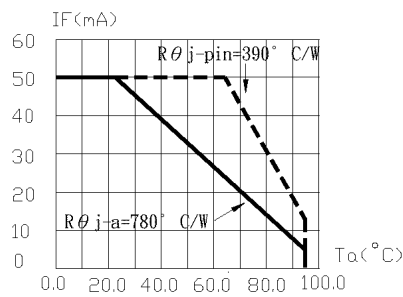


FIG.5 MAXIMUM FORWARD DC CURRENT VS AMBIENT TEMPERATURE ( $T_{jmax}=105^{\circ}C$ )

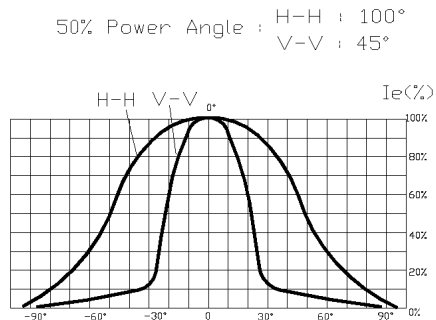


FIG.6 FAR FIELD PATTERN

1. Cathode PAD Area (0.18 × 0.18inch<sup>2</sup>)
2. Height above nominal seating plane in inches(0.3inch)